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SERIAL NUMBER 10/569,942	FILING or 371(c) DATE 02/28/2006 RULE	CLASS 438	GROUP ART UNIT 2812	ATTORNEY DOCKET NO. P29123	
APPLICANTS Akihiko Endo, Tokyo, JAPAN; [SJN] Hideki Nishihata, Tokyo, JAPAN; ** CONTINUING DATA ***** This application is a 371 of PCT/JP04/12633 09/01/2004 [SJN] ** FOREIGN APPLICATIONS ***** JAPAN 2003-309239 09/01/2003 [SJN] ** IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 05/05/2008					
Foreign Priority claimed <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No 35 USC 119(a-d) conditions met <input checked="" type="checkbox"/> Yes <input type="checkbox"/> No Verified and /SEAHVOSH J NIKMANESH/ Acknowledged Examiner's Signature	<input type="checkbox"/> Met after Allowance /SJN/ Initials	STATE OR COUNTRY JAPAN	SHEETS DRAWINGS 3	TOTAL CLAIMS 6	INDEPENDENT CLAIMS 1
ADDRESS GREENBLUM & BERNSTEIN, P.L.C. 1950 ROLAND CLARKE PLACE RESTON, VA 20191 UNITED STATES					
TITLE Method for Manufacturing Bonded Wafer					
FILING FEE RECEIVED 900	FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following:		<input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit		